

# 74CB3Q3257-Q100

4-bit 1-of-2 FET multiplexer/demultiplexer with charge pump

Rev. 2 — 11 April 2024

Product data sheet

## 1. General description

The 74CB3Q3257-Q100 is a quad high-bandwidth single-pole, double-throw FET bus switch. The device features one select input (S) and one output enable input (OE). The switch is disabled when the OE input is HIGH. An internal charge-pump increases the gate voltage of the NMOS pass transistor. The result is improved  $R_{ON}$  and  $R_{ON(Flat)}$  performance and the ability to switch 5 V signals when  $V_{CC} = 3.3$  V.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - Specified from -40 °C to +85 °C
- Wide supply voltage range from 2.3 V to 3.6 V
- Overvoltage switching on switch ports:
  - 0 V to 5 V switching with  $V_{CC} = 2.5$  V
  - 0 V to 5 V switching with  $V_{CC} = 3.3$  V
- 4  $\Omega$  (typical) ON resistance
- 3.5 pF (typical) OFF-state capacitance
- High bandwidth 0.5 GHz (maximum)
- Low input/output capacitance minimizes loading and signal distortion
- Fast switching frequency  $f_{max} = 20$  MHz (maximum)
- Low power consumption  $I_{CC} = 0.4$  mA (typical)
- Control inputs can be driven by TTL or 5 V/3.3 V CMOS outputs
- $I_{OFF}$  supports partial power-down mode operation
- Latch-up performance exceeds 100 mA per JESD 78E Class II Level A
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

## 3. Applications

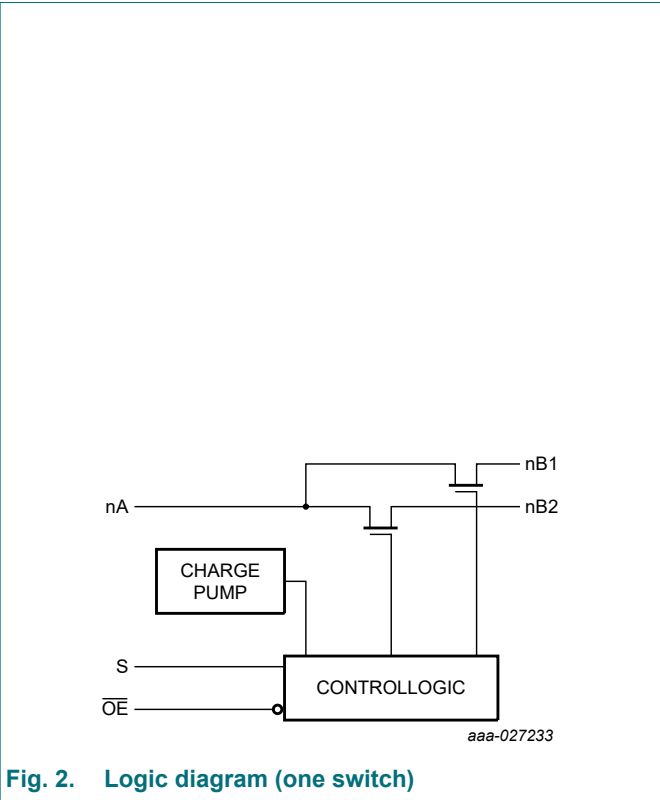
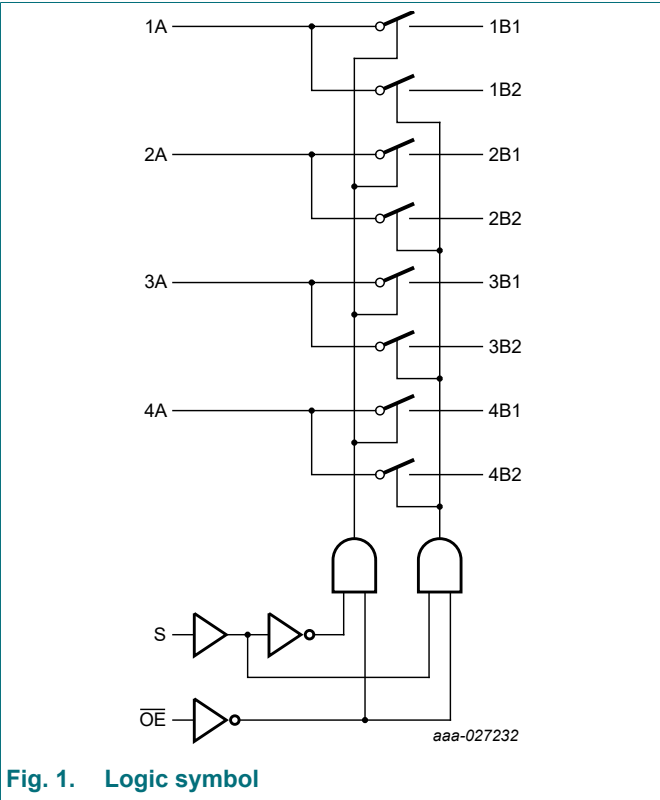
- Communication infrastructure
- Bus isolation
- Memory interleaving
- Sensor multiplexing

4. Ordering information

Table 1. Ordering information

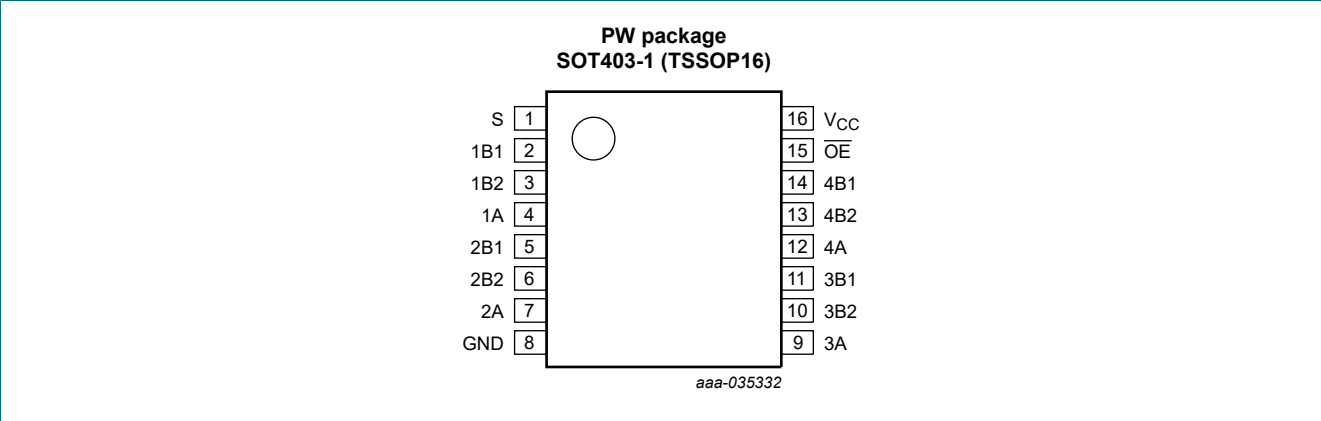
Type number	Package			
	Temperature range	Name	Description	Version
<a href="#">74CB3Q3257PW-Q100</a>	-40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	<a href="#">SOT403-1</a>

5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	select input
1B1, 1B2, 2B1, 2B2, 3B2, 3B1, 4B2, 4B1	2, 3, 5, 6, 10, 11, 13, 14	independent input or output
1A, 2A 3A, 4A	4, 7 9, 12	common output or input
GND	8	ground (0 V)
OE	15	output enable input (active-LOW)
V <sub>CC</sub>	16	supply voltage

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Input		Channel on
S	OE	
L	L	nA = nB1
H	L	nA = nB2
X	H	Z (switch off)

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
V <sub>I</sub>	input voltage	S, $\overline{\text{OE}}$ input [1]	-0.5	+7.0	V
V <sub>SW</sub>	switch voltage	[2]	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	-50	-	mA
I <sub>SK</sub>	switch clamping current	V <sub>I</sub> < -0.5 V	-50	-	mA
I <sub>SW</sub>	switch current		-	±120	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +85 °C [3]	-	500	mW

- [1] The minimum input voltage rating may be exceeded if the input current rating is observed.  
[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.  
[3] For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.3	3.6	V
V <sub>I</sub>	input voltage	S, $\overline{\text{OE}}$ input	0	5.5	V
V <sub>SW</sub>	switch voltage		0	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	S, $\overline{\text{OE}}$ input			
		V <sub>CC</sub> = 2.3 V to 2.7 V	0	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	0	10	ns/V

10. Static characteristics

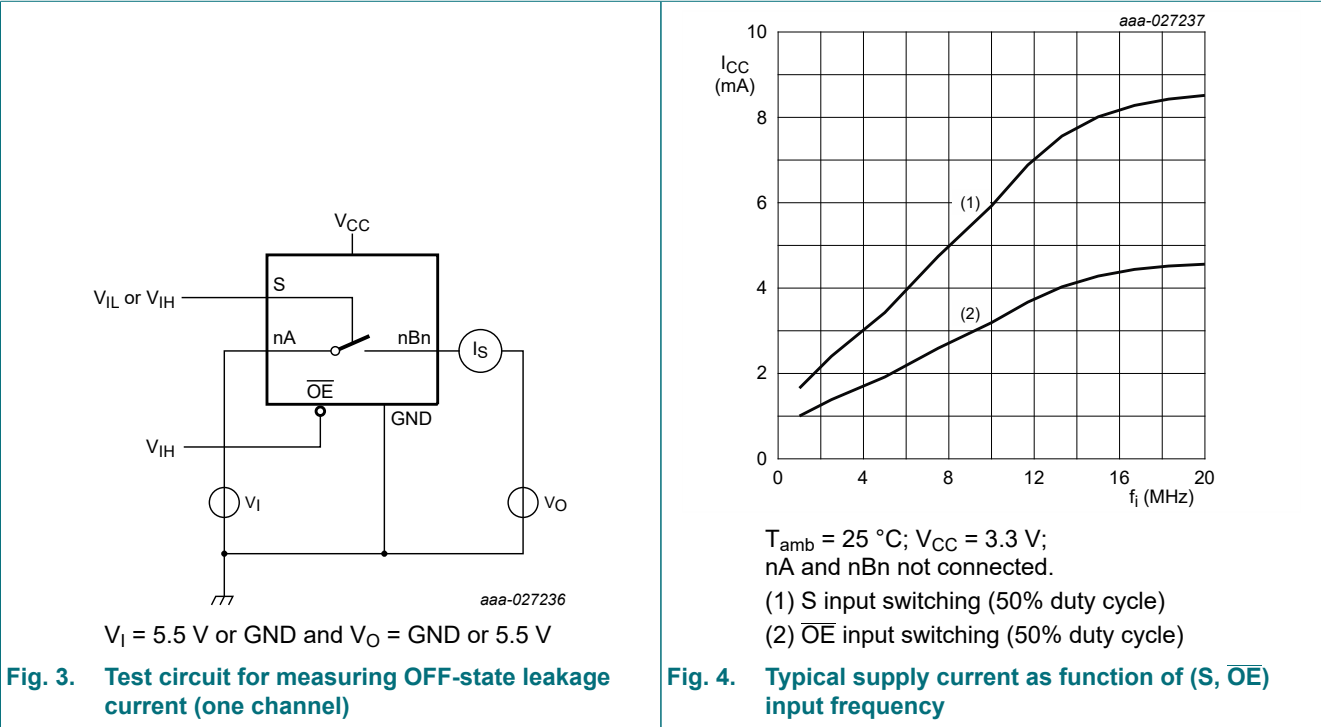
Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85°C		Unit
			Min	Typ[1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	-	2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	-	-	0.8	V
V <sub>IK</sub>	input clamping voltage	nA, nBn; V <sub>CC</sub> = 3.6 V; I <sub>I</sub> = -18 mA	-	-	-	-	-1.8	V
I <sub>I</sub>	input leakage current	S, $\overline{\text{OE}}$ ; V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = GND to 5.5 V	-	-	-	-	±1	µA
I <sub>OFF</sub>	power-off leakage current	per pin; V <sub>CC</sub> = 0 V; V <sub>SW</sub> or V <sub>I</sub> = 0 V to 5.5 V	-	-	-	-	±1	µA
I <sub>S(OFF)</sub>	OFF-state leakage current	nA, nBn; V <sub>CC</sub> = 3.6 V; see Fig. 3	-	-	-	-	±1	µA
I <sub>CC</sub>	supply current	V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A; V <sub>SW</sub> = GND or V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	-	0.4	-	-	0.6	mA
ΔI <sub>CC</sub>	additional supply current	S, $\overline{\text{OE}}$ ; V <sub>CC</sub> = 3.6 V; one input at 3 V, other inputs at GND or V <sub>CC</sub>	-	-	-	-	30	µA
C <sub>I</sub>	input capacitance	V <sub>CC</sub> = 3.3 V; V <sub>SW</sub> = GND or V <sub>CC</sub> ; V <sub>I</sub> = 0 V, 3.3 V, 5.5 V						
		S, $\overline{\text{OE}}$	-	2.5	-	-	3.5	pF
C <sub>S(OFF)</sub>	OFF-state capacitance	V <sub>CC</sub> = 3.3 V; V <sub>SW</sub> = 0 V, 3.3 V, 5.5 V						
		nA	-	5.5	-	-	7	pF
		nBn	-	3.5	-	-	5	pF
C <sub>S(ON)</sub>	ON-state capacitance	V <sub>CC</sub> = 3.3 V; V <sub>SW</sub> = 0 V, 3.3 V, 5.5 V						
		nA, nBn	-	10.5	-	-	13	pF

[1] Typical values are measured at V<sub>CC</sub> = 3.3 V unless otherwise specified.

10.1. Test circuit and graph



10.2. ON resistance

Table 7. ON resistance

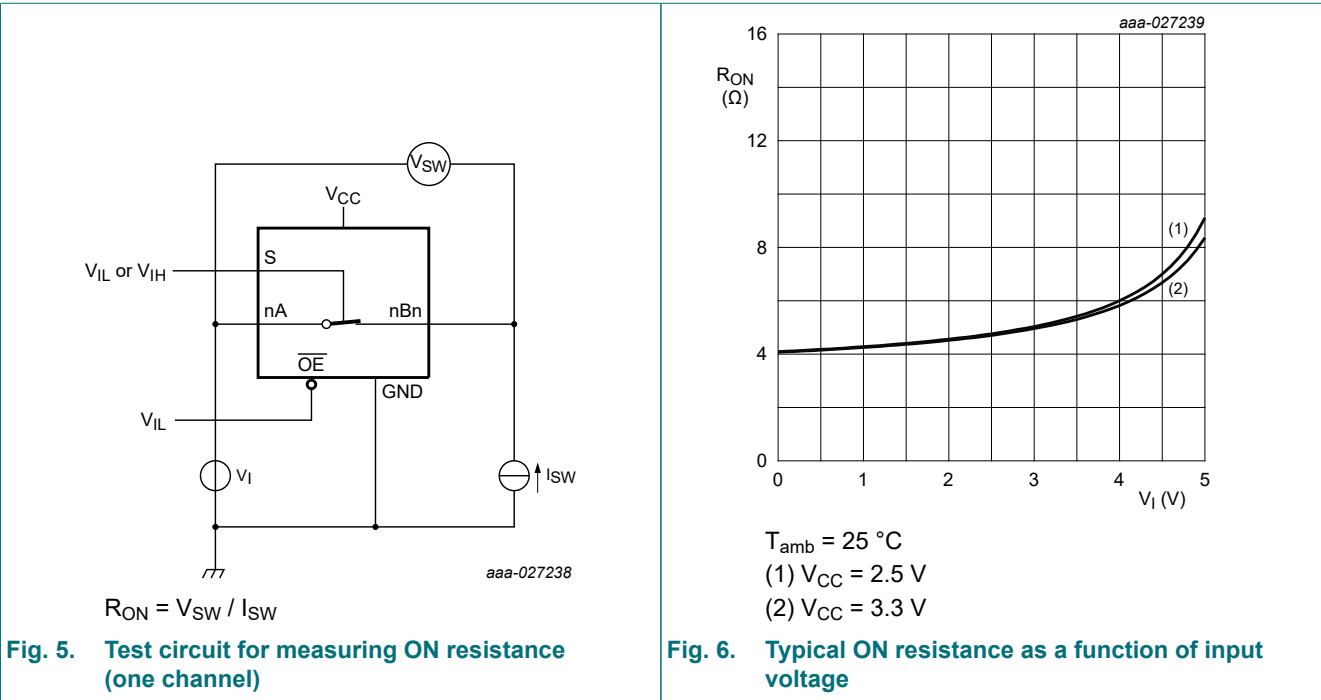
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.

Symbol	Parameter	Conditions	T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C		Unit
			Min	Typ	Max	Min	Max	
R <sub>ON</sub>	ON resistance	V <sub>CC</sub> = 2.3 V; see Fig. 6						
		V <sub>I</sub> = 0 V; I <sub>SW</sub> = 30 mA [1]	-	4	-	-	8	Ω
		V <sub>I</sub> = 1.7 V; I <sub>SW</sub> = -15 mA [1]	-	4.4	-	-	9	Ω
		V <sub>CC</sub> = 3.0 V; see Fig. 6						
		V <sub>I</sub> = 0 V; I <sub>SW</sub> = 30 mA [2]	-	4	-	-	6	Ω
		V <sub>I</sub> = 2.4 V; I <sub>SW</sub> = -15 mA [2]	-	4.7	-	-	8	Ω

[1] Typical values are measured at V<sub>CC</sub> = 2.5 V.

[2] Typical values are measured at V<sub>CC</sub> = 3.3 V.

10.3. ON resistance test circuit and graph



11. Dynamic characteristics

Table 8. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 9.

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °C to +85 °C		Unit
			Min	Max	
t <sub>pd</sub>	propagation delay	nA to nBn or nBn to nA; see Fig. 7 [1][2]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.12	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.20	ns
		S to nA; see Fig. 7 [1]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	6.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	5.5	ns
t <sub>en</sub>	enable time	OE to nA, nBn; see Fig. 8 [1]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	6.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	5.5	ns
		S to nBn; see Fig. 8 [1]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	6.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	5.5	ns
t <sub>dis</sub>	disable time	OE to nA, nBn; see Fig. 8 [1]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	6.0	ns
		S to nBn; see Fig. 8 [1]			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	6.0	ns
f <sub>max</sub>	maximum frequency	S, OE; V <sub>O</sub> > V <sub>CC</sub> ; V <sub>I</sub> = 5 V; R <sub>L</sub> ≥ 1 MΩ; C <sub>L</sub> = 0 pF			
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	10	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	20	MHz

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.  
t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.  
t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[2] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



11.1. Waveforms and test circuit

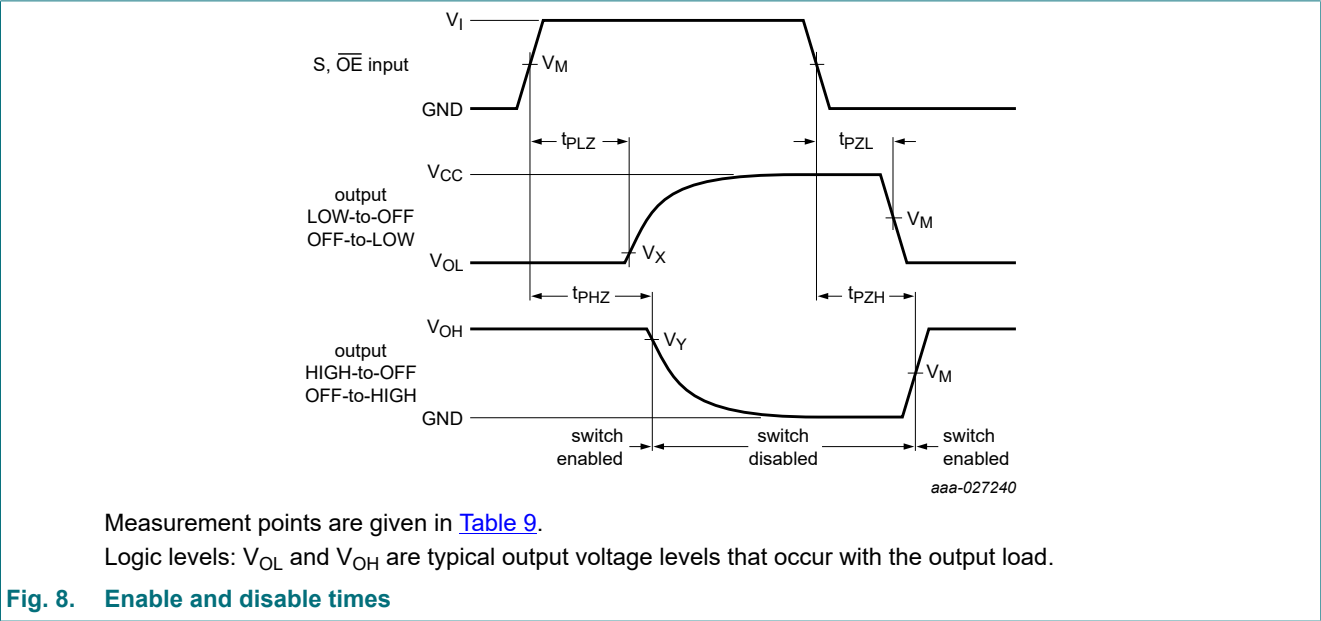
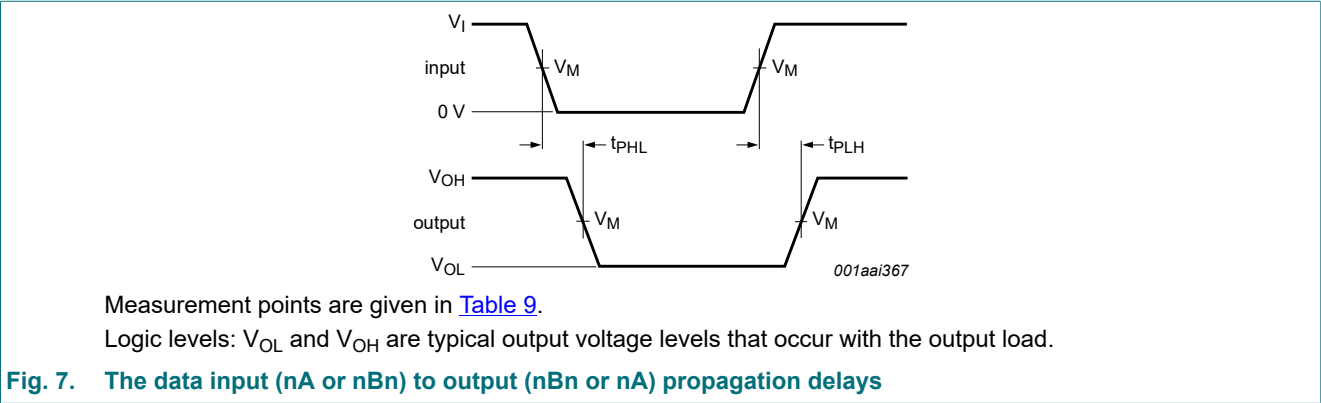
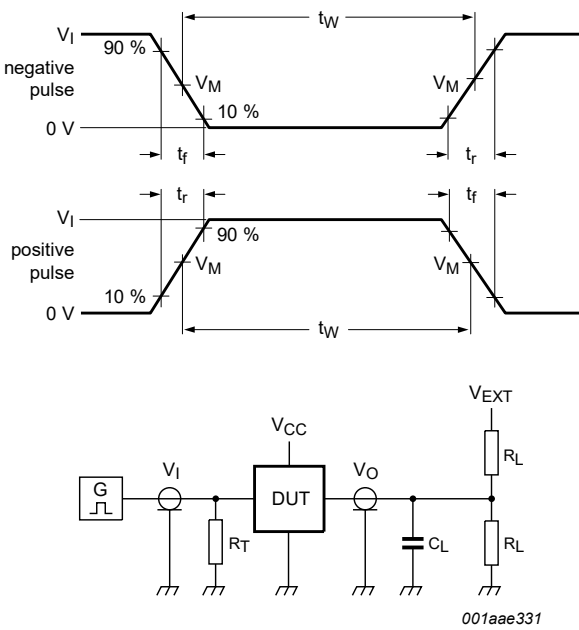


Table 9. Measurement points

Supply voltage	Input	Output		
$V_{CC}$	$V_M$	$V_M$	$V_X$	$V_Y$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
3.0 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



Test data is given in [Table 10](#).  
Definitions for test circuit:  
 $R_L$  = Load resistance.  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.5 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND
3.0 V to 3.6 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND

12. Package outline

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

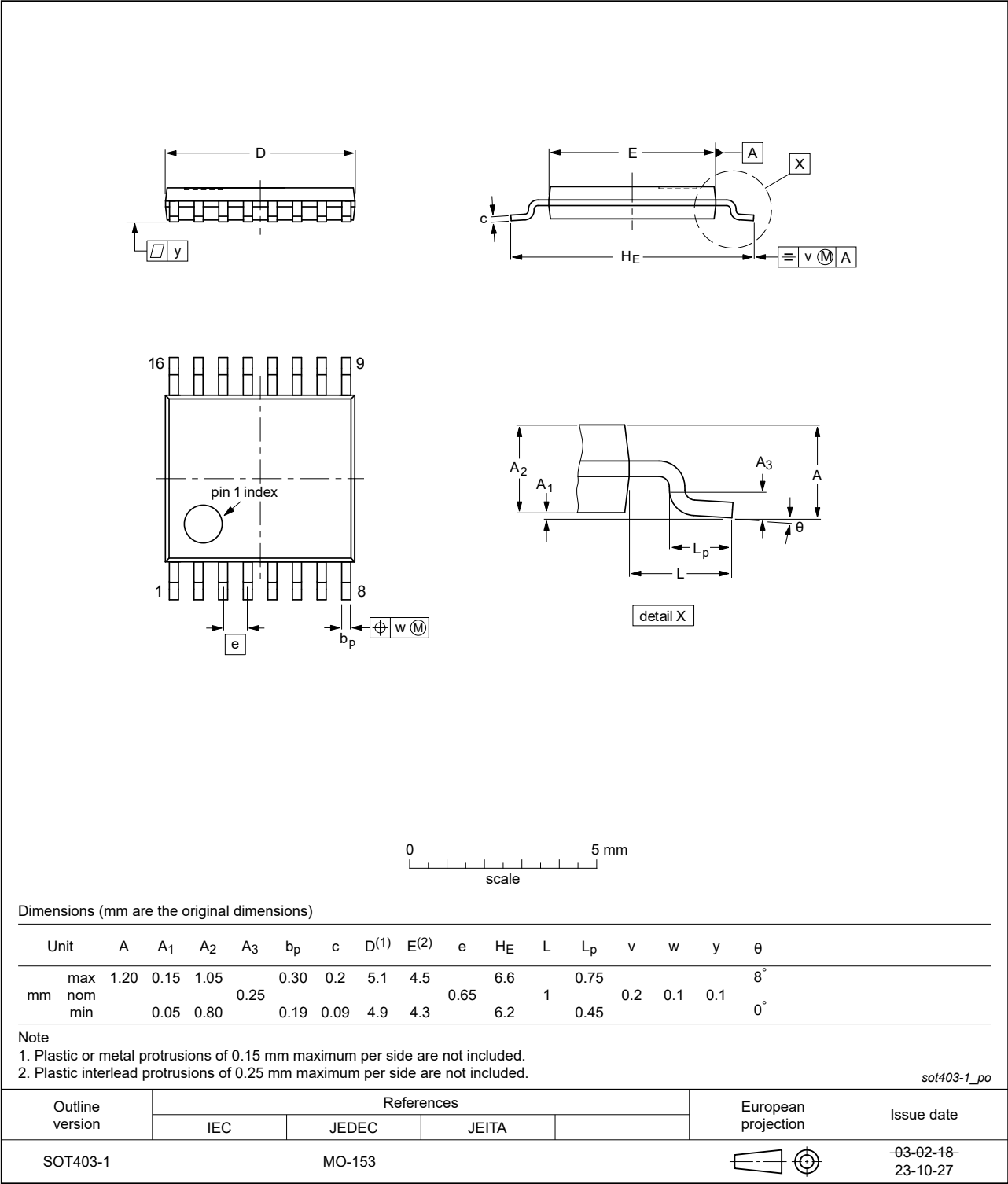


Fig. 10. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
FET	Field-Effect Transistor
HBM	Human Body Model
NMOS	N-channel Metal-Oxide Semiconductor
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74CB3Q3257_Q100 v.2	20240411	Product data sheet	-	74CB3Q3257_Q100 v.1
Modifications:	<ul style="list-style-type: none"><li>Fig. 10: Aligned TSSOP package outline drawing to JEDEC MO-153.</li><li>Section 2: ESD specification updated according to the latest JEDEC standard.</li></ul>			
74CB3Q3257_Q100 v.1	20190220	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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